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**REISSUE APPLICATION: CONSENT OF ASSIGNEE;  
STATEMENT OF NON-ASSIGNMENT**

Docket Number (Optional)

This is part of the application for a reissue patent based on the original patent identified below.

Name of Patentee(s) Fred Rheinlander and Richard D. Rhodes, Jr.

Patent Number 5,863,064

Date Patent Issued January 26, 1999

Title of Invention Skin For Automotive Air Bag Cover Panel Formed By Casting Different Plastic Materials

1. ☒ Filed herein is a statement under 37 CFR 3.73(b). (Form PTO/SB/96)
2. ☐ Ownership of the patent is in the inventor(s), and no assignment of the patent is in effect.

One of boxes 1 or 2 above must be checked. If multiple assignees, complete this form for each assignee. If box 2 is checked, skip the next entry and go directly to "Name of Assignee".

The written consent of all assignees and inventors owning an undivided interest in the original patent is included in this application for reissue.

The assignee(s) owning an undivided interest in said original patent is/are Textron Automotive Company, Inc. and the assignee(s) consents to the accompanying application for reissue.

Name of assignee/inventor (if not assigned)

Textron Automotive Company, Inc.

Signature

Date

1-25-01

Typed or printed name and title of person signing for assignee (if assigned)

John Clark; Executive Vice President/General Counsel

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